

(5,08mm) .200" HPF SERIES

## HPF-18-02-T-S HPF-10-01-T-S

## POWER SOCKETS

75°C

14.4A

12.7A

## **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?HPF

Insulator Material:
Black LCP
Contact Material:
BeCu
Plating: Sn over
50µ" (1,27µm) Ni
Insertion Depth:

(3,68mm) .145" to (8,26mm) .325" (.368" (9,35mm) plus board thickness minimum for bottom entry)
Wiping Distance: (0,38mm) .015"

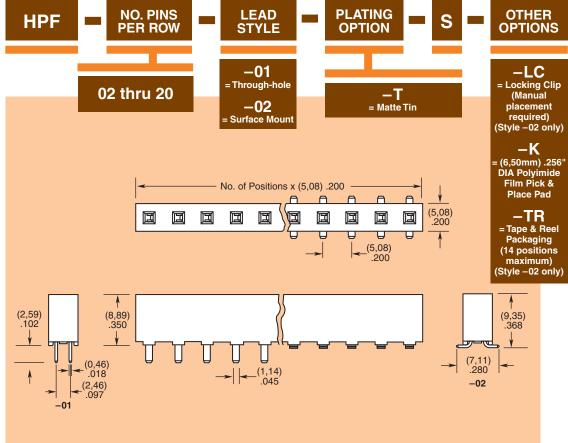
(0,38mm) .015"
Insertion Force:
(Single contact only)
5602 (15,57N) avg.
Withdrawal Force:
(Single contact only)
5202 (14,46N) avg.
Lead-Free Solderable:

SMT Lead Coplanarity: (0,15mm) .006" max (02-10) (0,20mm) .008" max (11-20) RoHS Compliant: Yes

Surface Mount Mates with: HPM, HPW Through-hole CONTACT **CURRENT RATING** HPM/HPF AMBIENT TEMP GGEDIZED 2 PINS 4 PINS 22A 20°C 25A SAMTEC (5,08mm) 24A 19A 40°C Three-finger .200" 17A 15.5A 60°C Power Eye contact

pitch

Locking clip option



**Note:** Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

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